

### DATA SHEET

# Si8935/36/37 Delta-Sigma Modulator for Voltage Measurement

### **Applications**

- Industrial, HEV and renewable energy inverters
- AC, brushless, and DC motor controls and drives
- Variable speed motor control in consumer white goods
- Isolated switch mode and UPS power supplies
- General industrial data acquisition and sensor interface
- Automotive on-board chargers, battery management systems, and charging stations

### **Features**

- 0 to 2.5 V nominal input voltage
- Modulator clock options
  - External clock up to 25 MHz (Si8935)
  - 10 MHz internal clock (Si8936)
  - 20 MHz internal clock (Si8937)
- Typical input offset: ±0.4 mV
- Typical gain error: ±0.05%
- Excellent drift specifications
  - ±0.5 μV/°C typical offset drift
- 9 ppm/°C typical gain drift
- Typical nonlinearity: 0.003%
- Typical SNR: 86 dB
- High common-mode transient immunity: 75 kV/μs
- Automotive-grade OPNs available
  - AEC-Q100 qualification
  - AIAG-compliant PPAP documentation support
- IMDS and CAMDS listing support
- Compact packages
  - 8-pin wide body stretched SOIC
  - 8-pin narrow body SOIC
- -40 to 125 °C

## **Safety Approvals**

- UL 1577 recognized
- Up to 5000 V<sub>RMS</sub> for 1 minute
- CSA approval
  - 62368-1 (reinforced insulation)
- VDE certification conformity
  - EN62368-1 (reinforced insulation)
    - Pending IEC60747-17 (basic/reinforced insulation)
- CQC certification approval
  - GB4943.1-2011, GB4943.1-2022



Figure 1. Si8935/36/37 Block Diagram

### Description

The Si8935/36/37 are galvanically isolated delta-sigma modulators optimized for voltage sensing. Its 2.5 V input range is ideal for isolated voltage sensing applications. The Si8935/ 36/37 provides excellent linearity with low offset and gain drift to ensure that accuracy is maintained over the entire operating temperature range. Exceptionally high commonmode transient immunity means that the Si8935/36/37 delivers accurate measurements even in the presence of highpower switching found in motor drive systems and inverters.

The output of the Si8935/36/37 comes from a second-order, delta-sigma modulator. The modulator can be clocked either from an on-board oscillator (Si8936/37) or from an external clock (Si8935). The output is typically digitally filtered by a MCU or FPGA in the system.

The Si8935/36/37 isolated delta-sigma modulators utilize Skyworks proprietary isolation technology. It supports up to 5.0 kV<sub>RMS</sub> withstand voltage per UL1577. This technology enables higher performance, reduced variation with temperature and age, tighter part-to-part matching, and longer lifetimes compared to other isolation technologies.

Automotive Grade is available for certain part numbers. These products are built using automotive-specific flows at all steps in the manufacturing process to ensure the robustness and low defectivity required for automotive applications.



Skyworks Green<sup>™</sup> products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*<sup>™</sup>, document number SQ04–0074.

# 1. Pin Descriptions





#### Table 1. Si8931 Pin Descriptions

Name	Pin Number	Description	
VDDA	1	Input side power supply	
VIN	2	Voltage input	
NC <sup>1</sup>	3	No connect	
GNDA	4	Input side ground	
GNDB	5	Output side ground	
ADAT	6	Delta-sigma modulator data output	
ACLK	7	Delta-sigma modulator clock (input on Si8935, output on Si8936/37)	
VDDB	8	Output side power supply	

1. No Connect. These pins are not internally connected. To maximize CMTI performance, these pins should be connected to the ground plane.

# 2. Technical Description

The input to the Si8935/36/37 is designed for 0 to 2.5 V nominal.

The analog input stage of the Si8935/36/37 is a single-ended amplifier feeding the input of a second-order, deltasigma modulator that digitizes the input signal into a 1-bit output stream. The isolated data output ADAT pin of the converter provides a stream of digital ones and zeros that is synchronous to the ACLK pin. The Si8936/37 clock is generated internally while the Si8935 clock is provided externally. The time average of this serial bit-stream output is proportional to the analog input voltage.



Figure 3. Si8935/36/37 Functional Block Diagram

# 3. Fail-Safe and Low-Power Modes

The Si8935/36/37 implements a fail-safe output when the high voltage-side supply (VDDA) goes away. The fail-safe output is steady state logic 0 on ADAT for the externally clocked Si8935. The fail-safe output is a steady state logic 1 on ADAT for the internally clocked Si8936/37. The clock output ACLK of the Si8946/47 will stop after 256 cycles with a steady state logic 1. When the supply comes back, the clock will be turned back on and normal DSM data stream will be output in approximately 200 is. To differentiate from the fail-safe output, a maximum nominal input signal will generate a single one every 128 bits at ADAT.

In addition to the fail-safe output, when a loss of VDDA supply occurs, the part will automatically move into a lower power mode that reduces IDDB current to approximately 1 mA. Similarly, a loss of VDDB supply will reduce IDDA current to approximately 1 mA. When the supply voltage is returned, normal operation begins in approximately 250 µs.

# 4. Modulator

The output of the Si8935/36/37 comes from a second-order, delta-sigma modulator like that shown in the figure below. The modulator provides 1-bit data stream whose average represents the input analog voltage. Zero volts across the inputs is represented at the output by a pulse train that has 50% ones density. Specified linear full-scale at the input (e.g., +2.25 V) produces an output data stream that has 92.87% ones density.



Figure 4. Typical 2nd Order Delta-Sigma Modulator Block Diagram

Single-Ended Input (V)	Bit Stream % Ones
2.25	92.87
1.125	71.44
0	50

Table 2	. Modulator	Output
	. moudiates	output

# 5. Voltage Sense Application

A typical isolated voltage sensing application circuit is shown below. In this example, a high voltage is divided down to produce a voltage (VIN) within the optimum input signal range of the Si8935/36/37. Numerous alternative inputs configurations are possible with the flexibility of a high impedance input isolator. The Si8935/36/37 senses the single-ended input voltage where it is oversampled and converted into a 1-bit bitstream, then transmitted across the isolation barrier to be processed by the system controller/FPGA. If the voltage sensed is > 2.5 V, a simple voltage divider consisting of R1 and R2 can be used to scale down any voltage to fit the input range of the Si8935/36/37. R2 < 10 k $\Omega$  is recommended for best performance.



Figure 5. Voltage Sense Application

The Si8935/36/37 has intrinsic low-pass filtering at approximately 800 kHz. For applications where input filtering is required, a passive RC low-pass filter can be placed at the input pin. Consider the source resistance of the signal measured (or the parallel combination of R1 and R2 if using a voltage divider) as it should be included in the filter calculation. Capacitor C1 should be sized to make a band limiting filter at the desired frequency.

C4, the local bypass capacitor for the B-side of the Si8935/36/37, should be placed close to the VDDB supply pin with its return close to GNDB. The output signal typically goes directly to a digital filter for additional processing. The digital filter may be implemented by a dedicated FPGA in the system or may be a peripheral in the main system controller. The Si8935 expects an external clock to provide the clock signal for the modulator. That external clock can be provided by the same device that implements the digital filtering or another device that syncs both the modulator and the digital filter. The Si8936/37 generates an internal clock to the digital filter.

# 6. Electrical and Mechanical Specifications

The absolute maximum ratings of the Si8935/36/37 are provided below, followed by electrical specifications, performance graphs, and mechanical specifications.

Parameter	Symbol	Min	Max	Unit
Storage temperature	Tstg	-65	150	°C
Ambient temperature under bias	Та	-40	125	°C
Junction temperature	ιT		150	°C
Supply voltage	VDDA, VDDB	-0.5	6.0	v
Input voltage respect to GNDA	VIN	-0.5	VDDA + 0.5	v
Output sink or source current	10		5	mA
Total power dissipation	Рт		212	mW
Lead solder temperature (10 s)			260	°C
Human Body Model ESD rating		6000		V
Charged Device Model ESD rating		2000		V

#### Table 3. Si8931 and Si8932 Absolute Maximum Ratings<sup>1</sup>

1. Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD Handling: Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

### Table 4. Si8935/36/37 Electrical Specifications<sup>1</sup>

TA = -40 to +125 °C, SINC3 filter with 256 oversampling ratio and 20 MHz clock; typical specs at 25 °C and VDDA = VDDB = 5V unless specified otherwise

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Input side supply voltage	VDDA		3.0		5.5	V
Input supply current	IDDA	VDDA = 3.3 V	5.1	7	8.7	mA
Output side supply voltage	VDDB		3.0		5.5	V
Output supply current (si8935)	IDDB	VDDB = 3.3 V	1	1.8	2.7	mA
Output supply current (si8936)	IDDB	VDDB = 3.3 V	2.3	4.4	7.2	mA
Output supply current (si8937)	IDDB	VDDB = 3.3 V	3.4	6.1	11	mA
Amplifier input						
Specified linear in- put range	VIN		0.25		2.25	V
Maximum input voltage before clipping	VIN			2.5		V
Input referred offset	VOS	TA = 25 °C, VIN = 0.25 V	-3	±0.4	3	mV
Input offset drift	VOSt		-40	±0.5	25	μV/°C
Input impedance	RIN			500		MΩ
Dynamic Characteristics						
Gain				1		
Gain error		TA = 25 °C	-0.15	±0.05	0.15	%
Gain error drift			-7	9	20	ppm/°C
Nonlinearity		TA = 25 °C	-0.016	0.003	0.016	%
Nonlinearity drift			-1		1	ppm/°C
Signal-to-noise ratio	SNR	FIN = 5 kHz BW = 40 kHz (Si8935/37) BW = 20 kHz (Si8936)	73	86		dB
Total harmonic distortion	THD	FIN = 5 kHz BW = 40 kHz (Si8935/37) BW = 20 kHz (Si8936)		-83	-60	dB
Common-mode transient immunity	CMTI	VIN = GNDA, VCM = 1500 V	50	75		kV/μs
		VDDA at DC		-100		dB
		VDDA at 100 mV and 10 kHz ripple		-100		dB
Power-supply rejection	DCDD	VDDB at DC		-100		dB
ratio	PJNN	VDDB at 100 mV and 10 kHz ripple		-100		dB
Digital			1 1			
Logic high input threshold (Si8935)	VIH		85% of VDDB			V
Logic low input threshold (Si8935)	VIL				15% of VDDB	V
Input hysteresis	VIHYST			120		mV
Output load capacitance	CLOAD			15		pF
External Clock (Si8935)						
Clock frequency	FCLKIN		5		25	MHz
Duty cycle	FDUTY		45	50	55	%
Delay to data valid	TDELAY				23	ns

# Table 4. Si8935/36/37 Electrical Specifications<sup>1</sup> (Continued)

TA = -40 to +125 °C, SINC3 filter with 256 oversampling ratio and 20 MHz clock; typical specs at 25 °C and VDDA = VDDB = 5V unless specified otherwise

Parameter	Symbol	Test Condition	Min	Тур	Max	Units			
Data hold time	THOLD		6			ns			
Internal Clock (si8936)	Internal Clock (si8936)								
		TA = 25 °C	9.9	10	10.1	MHz			
Clock frequency	FCLKOUT	T <sub>A</sub> = -40 °C to 125 °C	9.8	10	10.2	MHz			
Duty cycle	FDUTY		45	50	55	%			
Delay to data valid	TDELAY				60	ns			
Data hold time	THOLD		40			ns			
Internal Clock (Si8937)		-		I	I				
		T <sub>A</sub> = 25 °C	19.8	20	20.2	MHz			
Clock frequency	FCLKOUT	TA = -40 °C to 125 °C	19.6	20	20.4	MHz			
Duty cycle	FDUTY		45	50	55	%			
Delay to data valid	TDELAY				30	ns			
Data hold time	THOLD		20			ns			

1. Performance is guaranteed only under the conditions listed in this Table and is not guaranteed over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.



Figure 8. Common-Mode Transient Immunity Characterization Circuit

Parameter	Symbol	Test Condition	Characteristic	Unit
Safety temperature	Τ <sub>S</sub>		150	°C
Safety input current (WB stretched SOIC-8)	Ŀ	$\theta_{JA} = 90 \text{ °C/W}$ VDD = 5.5 V T <sub>J</sub> = 150 °C T <sub>A</sub> = 25 °C	253	mA
	'5	$\theta_{JA} = 90 \text{ °C/W}$ VDD = 3.6 V T <sub>J</sub> = 150 °C T <sub>A</sub> = 25 °C	386	mA
Safety input current (NR SOIC-R)	١ <sub>S</sub>	$\theta_{JA} = 112 \text{ °C/W}$ VDD = 5.5 V T <sub>J</sub> = 150 °C T <sub>A</sub> = 25 °C	203	mA
Salety input current (NB SOLES)		$\theta_{JA} = 112 \text{ °C/W}$ VDD = 3.6 V T <sub>J</sub> = 150 °C T <sub>A</sub> = 25 °C	310	mA
Safety input power (WB stretched SOIC-8)	P <sub>S</sub>	θ <sub>JA</sub> = 90 °C/W T <sub>J</sub> = 150 °C TA = 25 °C	1389	mW
Safety input power (NB SOIC-8)	Ps	θ <sub>JA</sub> = 112 °C/W T <sub>J</sub> = 150 °C T <sub>A</sub> = 25 °C	1116	mW

### Table 5. IEC 60747-17 Safety Limiting Values<sup>1</sup>

1. Maximum value allowed in the event of a failure. Refer to the thermal derating curves below.



**Table 6. Thermal Characteristics** 

Figure 9. WB Stretched SOIC-8 Thermal Derating Curve for Safety Limiting Current



Figure 10. NB SOIC-8 Thermal Derating Curve for Safety Limiting Current

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# 7. Typical Performance Characteristics













Figure 12. Si8935 Nonlinearity (%) vs. VDDA Supply (V)



Figure 14. Si8936 Nonlinearity (%) vs. Input Signal Amplitude (mV)











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Figure 35. Si8932 High-to-Low Step Response

# 8. Regulatory Information

# Table 7. Regulatory Information (Pending)<sup>1, 2</sup>

CSA
The Si8935/36/37 is certified under CSA. For more details, see Master Contract File 232873.
62368-1: Up to 600 V <sub>RMS</sub> reinforced insulation working voltage; up to 1000 V <sub>RMS</sub> basic insulation working voltage.
VDE
The Si8935/36/37 is pending certification according to IEC60747-17 and conforms to 62368-1. For more details, see File 5028467.
IEC60747-17: Up to 2121 V <sub>peak</sub> for reinforced insulation working voltage.
EN62368-1: Up to 600 V <sub>RMS</sub> reinforced insulation working voltage; up to 1000 V <sub>RMS</sub> basic insulation working voltage.
UL
The Si8935/36/37 is certified under UL1577 component recognition program. For more details, see File E257455.
Rated up to 5000 V <sub>RMS</sub> isolation voltage for basic protection.
cqc
The Si8935/36/37 is certified under GB4943.1-2011 and GB4943.1-2022.
Rated up to 250 V <sub>RMS</sub> reinforced insulation working voltage at 5000 meters.

Daramatar	Symbol	Test Condition	Valu	Unit	
Parameter	Symbol		WB Stretched SOIC-8	NB SOIC-8	Onit
Nominal external air gap (clearance)	CLR		8.0	4.0	mm
Nominal external tracking (creepage)	CRP		8.0	4.0	mm
Minimum internal gap (internal clearance)	DTI		36	36	μm
Tracking resistance	PTI or CTI	IEC60112	600	600	V
Erosion depth	ED		0.04	0.04	mm
Resistance (input-output) <sup>1</sup>	Rio		1012	10 <sup>12</sup>	Ω
Capacitance (input-output) <sup>1</sup>	Сю	f = 1 MHz	1	1	pF

#### Table 8. Insulation and Safety-Related Specifications

1. To determine resistance and capacitance, the Si8931/32 is converted into a two-terminal device. Pins 1 to 4 are shorted together to form the first terminal, and pins 5 to 8 are shorted together to form the second terminal. The parameters are then measured between these two terminals.

#### Table 9. IEC 60664-1 Ratings

Parameter	Test Conditions	Specification		
i didilicitei		WB Stretched SOIC-8	NB SOIC-8	
Basic isolation group	Material group	l	I	
	Rated mains voltages ≤ 150 V <sub>RMS</sub>	I-IV	I-IV	
Overvoltage category	Rated mains voltages ≤ 300 V <sub>RMS</sub>	I-IV	I-IV	
	Rated mains voltages ≤ 600 V <sub>RMS</sub>	I-IV	1-111	

#### Table 10. IEC 60747-17 Insulation Characteristics<sup>1</sup>

			Characteristic		
Parameter	Symbol	Test Condition	WB Stretched SOIC-8	NB SOIC-8	Unit
Maximum working insulation voltage	V <sub>IOWM</sub>		1500	1500	V <sub>RMS</sub>
Maximum repetitive isolation voltage	V <sub>IORM</sub>		2121	2121	Vpeak
Input to output test voltage	V <sub>PR</sub>	Method b1 (VIORM x 1.875 = VPR, 100% production test, tm = 1 sec, Partial discharge < 5 pC)	3976	3976	Vpeak
Maximum transient isolation overvoltage	V <sub>IOTM</sub>	t = 60 sec	8000	4000	Vpeak
Maximum surge isolation voltage	V <sub>IOSM</sub>	Test voltage is ≥ 1.3 x VIMP, minimum 10000 Vpeak and 1.2 μs/50 μs	10400	10400	Vpeak
Maximum impulse voltage	VIMP		8000	5656	Vpeak
Pollution degree		DIN VDE 0110	2	2	
Insulation resistance	R <sub>S</sub>	TAMB = TS, VIO = 500 V	>10 <sup>9</sup>	>10 <sup>9</sup>	Ω

1. This isolator is suitable for reinforced electrical isolation only within the safety limit data. Maintenance of the safety data is ensured by protective circuits. The Si8935/36/37 provides a climate classification of 40/125/21.

# 9. Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The Si8935D-IS4, Si8936D-IS4, Si8937D-IS4, Si8935D-AS4, Si8936D-AS4, and Si8937D-AS4 are rated to Moisture Sensitivity Level 2A (MSL2A) at 260°C, while the Si8935B-IS, Si8936B-IS, Si8937B-IS, Si8935B-AS, Si8936B-AS, and Si8937B-AS are rated to MSL2 at 260°C.

They can be used for lead or lead-free soldering. For additional information, refer to Skyworks Application Note, "PCB Design and SMT Assembly/Rework Guidelines," Document Number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Refer to Standard SMT Reflow Profiles: JEDEC Standard J-STD-020.

# 9.1. Package Outline: 8-Pin Wide Body Stretched SOIC



Figure 36. 8-Pin Wide Body Stretched SOIC Package

Dimension	Millimeters		Notes
Dimension	Min	Max	Notes
А	2.49	2.79	
A1	0.36	0.46	*
b	0.30	0.51	*
С	0.20	0.33	*
D	5.74	5.94	All dimensions shown are in millimeters (mm) unless
E	11.25	11.76	otherwise noted.
E1	7.39	7.59	Dimensioning and tolerancing per ANSI Y14.5M-1994.
е	1.27	BSC	Pacammandad raflow profile par JEDEC   STD 020C
L	0.51	1.02	specification for small body, lead-free components.
h	0.25	0.76	*
θ	0°	8°	*
ааа		0.25	*
bbb		0.25	*
CCC		0.10	

### 9.2. Land Pattern: 8-Pin Wide Body Stretched SOIC

#### 9.2.1. General Guidelines

- 1. All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a fabrication allowance of 0.05 mm.
- 2. This land pattern design is based on the IPC-7351 guidelines.

#### 9.2.2. Solder Mask Design

- 1. All metal pads are to be non-solder mask defined (NSMD).
- 2. Clearance between the solder mask and the metal pad is to be 60  $\mu m$  minimum, all the way around the pad.

#### 9.2.3. Stencil Design

- 1. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 2. The stencil thickness should be 0.125 mm (5 mils).
- 3. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pins.

#### 9.2.4. Card Assembly

- 1. A No-clean, Type-3 solder paste is recommended.
- 2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.



Figure 37. 8-Pin Wide Body Stretched SOIC Land Pattern

Table 12. 8-Pin Wide Body Stretched SOIC Land Pattern Dimensions<sup>1</sup>

Dimension	(mm)	
C1	10.60	
E	1.27	
X1	0.60	
Y1	1.85	

1. See General Guidelines

### 9.3. Top Marking: 8-Pin Wide Body Stretched SOIC



Figure 38. Si8931/32 Typical Package Marking, 8-Pin Wide Body Stretched SOIC

Line 1	Part Number	Si893x X = Base part number 5 = External clock 6 = Internal 10 MHz clock 7 = Internal 20 MHz clock V = Insulation rating: D = 5.0 kV <sub>RMS</sub>
Line 2	ТТТТТТ	Manufacturing Code
Line 3	YY = Year WW = Work Week Circle = 43 mils diameter left justified	Year and work week

Table 13: 8-Pin Wide Body Stretched SOIC Top Marking Explanation



### 9.4. Tape and Reel Information: 8-Pin Wide Body Stretched SOIC





### 9.5. Package Outline: 8-Pin Narrow Body SOIC



Figure 41. 8-Pin Narrow Body SOIC Package

Dimonsion	Millimeters		Natas	
Dimension	Min	Max	Notes	
A	1.35	1.75		
A1	0.10	0.25	All dimonsions shown are in millimotors	
A2	1.40 REF	1.55 REF	(mm) unless otherwise noted.	
В	0.33	0.51	Dimonsioning and tolorancing por ANSI	
C	0.19	0.25	Y14.5M-1982.	
D	4.80	5.00	This drawing conforms to IEDEC Outling	
E	3.80	4.00	MS-012.	
e	1.27 BSC		Becommended card reflew profile is per	
н	5.80	6.20	the JEDEC/IPC J-STD-020B specification	
h	0.25	0.50	for small body components.	
L	0.40	1.27	_	
α	0°	8°		

#### Table 14. 8-Pin Narrow Body SOIC Package Dimensions

### 9.6. Land Pattern: 8-Pin Narrow Body SOIC

#### 9.6.1. General Guidelines

- 1. All feature sizes shown are at Maximum Material Condition (MMC) and a card fabrication tolerance of 0.05 mm is assumed.
- 2. This Land Pattern Design is based on IPC-7351 pattern SOIC127P600X173-8N for Density Level B (Median Land Protrusion).



Figure 42. 8-Pin Narrow Body SOIC Land Pattern

Dimension	mm
C1	5.40
E	1.27
X1	0.60
Y1	1.55

1. See General Guidelines

### 9.7. Top Marking: 8-Pin Narrow Body SOIC



Figure 43. Si8931/32 Typical Package Marking, 8-Pin Narrow Body SOIC

Line 1	Part Number	Si893x X = Base part number 5 = External clock 6 = Internal 10 MHz clock 7 = Internal 20 MHz clock V = Insulation rating B = 2.5 kV <sub>RMS</sub>
	CC = Country of origin ISO code abbreviation	
Line 2	YY = Year WW = Work Week	Year and work week
Line 3	TTTTTT = Manufacturing code Circle = 19.7 mils diameter left justified	Manufacturing code

Table 16. 8-Pin Narrow Body SOIC Top Marking Explanation



### 9.8. Tape and Reel Information: Narrow Body

FRONT VIEW



206440-045

SIDE VIEW

CARRIER TAPE WIDTH 12.00 MM +0.3 -0.0 MM



# **10. Ordering Information**

### 10.1. Industrial and Automotive Grade Ordering Part Numbers (OPNs)

Industrial-grade devices (part numbers with an "-I" in their suffix) are built using well-controlled, highquality manufacturing flows to ensure robustness and reliability. Qualifications are compliant with JEDEC, and defect reduction methodologies are used throughout definition, design, evaluation, qualification, and mass production steps.

Automotive-grade devices (part numbers with an "-A" in their suffix) are built using automotive-specific flows at all steps in the manufacturing process to ensure robustness and low defectivity. These devices are supported with AIAG-compliant Production Part Approval Process (PPAP) documentation, and feature International Material Data System (IMDS) and China Automotive Material Data System (CAMDS) listings. Qualifications are compliant with AEC-Q100, and a zero-defect methodology is maintained throughout definition, design, evaluation, qualification, and mass production steps.

Ordering		Ordering Options		
Part Number (OPN)	Automotive OPN <sup>5</sup>	Isolation Rating	Clock	Package Type
Si8935D-IS4	Si8935D-AS4	5.0 kVrms	Input	WB Stretched SOIC-8
Si8935B-IS	Si8935B-AS	2.5 kVrms	Input	NB SOIC-8
Si8936D-IS4	Si8936D-AS4	5.0 kVrms	10 MHz output	WB Stretched SOIC-8
Si8936B-IS	Si8936B-AS	2.5 kVrms	10 MHz output	NB SOIC-8
Si8937D-IS4	Si8937D-AS4	5.0 kVrms	20 MHz output	WB Stretched SOIC-8
Si8937B-IS	Si8937B-AS	2.5 kVrms	20 MHz output	NB SOIC-8

#### Table 17. Si8935-36-37 Ordering Guide<sup>1, 2, 3, 4</sup>

1. All packages are RoHS-compliant.

2. "Si" and "SI" are used interchangeably.

3. An "R" at the end of the part number denotes tape and reel packaging option.

4. In the top markings of each device, the Manufacturing Code represented by "TTTTTT" contains as its first character a letter in the range N through Z to indicate Automotive Grade.

5. Automotive-Grade devices ("-A") suffix) are identical in construction materials, topside marking, and electrical parameters to their Industrial-Grade ("-I" suffix) version counterparts. Automotive-Grade products are produced utilizing full automotive process flows and additional statistical process controls throughout the manufacturing flow. The Automotive-Grade part number is included on shipping labels.

# **Revision History**

#### **Revision B**

#### May, 2023

Re-formatted to new standards. Added new text for Automotive Grade products, AEC-Q100 qualification, updated regulatory information, added tape and reel information, and added MSL ratings.

#### Revision 206440A

#### December, 2022

Updated decimal-based revision number to alphanumeric code.

#### **Revision 0.8**

September, 2022

Updated Safety Approvals, minimum supply currents in Electrical Specifications, and Regulatory Information.

#### **Revision 0.7**

April, 2021

Updated Applications and Key Features, added Automotive OPNs to Ordering Guide, updated Insulation and Safety-Related Specifications, Electrical Specifications after full characterization, updated narrow body top marking, and numerous clarifications throughout.

**Revision 0.1** 

March, 2019

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